



**Opto Plus LED Corp.**  
**0.56" Case Mold Type LED Display**  
**OPD-T5620LB-BW**  
**OPD-T5621LB-BW**

● **EDIT HISTORY**

Version A : Feb. 24, 2015

Preliminary Spec.

Version B : Apr. 20, 2022

Modify Electrical Character & Curve (P4,P5)

Add package dimensions.

| Prepared by | Checked by | Approved by |
|-------------|------------|-------------|
|             |            |             |



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## 0.56" Case Mold Type LED Display

### OPD-T5620LB-BW

### OPD-T5621LB-BW

## ● FEATURES

- 0.56 inch (14.20 mm) Digit Height.
- Low current operation.
- Case mold type.
- Black face, White segment.
- RoHS compliant, Pb Free.

## ● DESCRIPTION

The OPD-T5620LB-BW & OPD-T5621LB-BW is a 0.56 inch (14.20 mm) Height triple digits display.

This device utilizes Super Bright Blue LED chip which are made from InGaN on a transparent GaN substrate. The display has Black face, White segment.

## ● DEVICE

| PART NO<br>Super Bright Blue | DESCRIPTION    |
|------------------------------|----------------|
| OPD-T5620LB-BW               | Common Anode   |
| OPD-T5621LB-BW               | Common Cathode |

**RoHS Compliance**



**Pb free.**



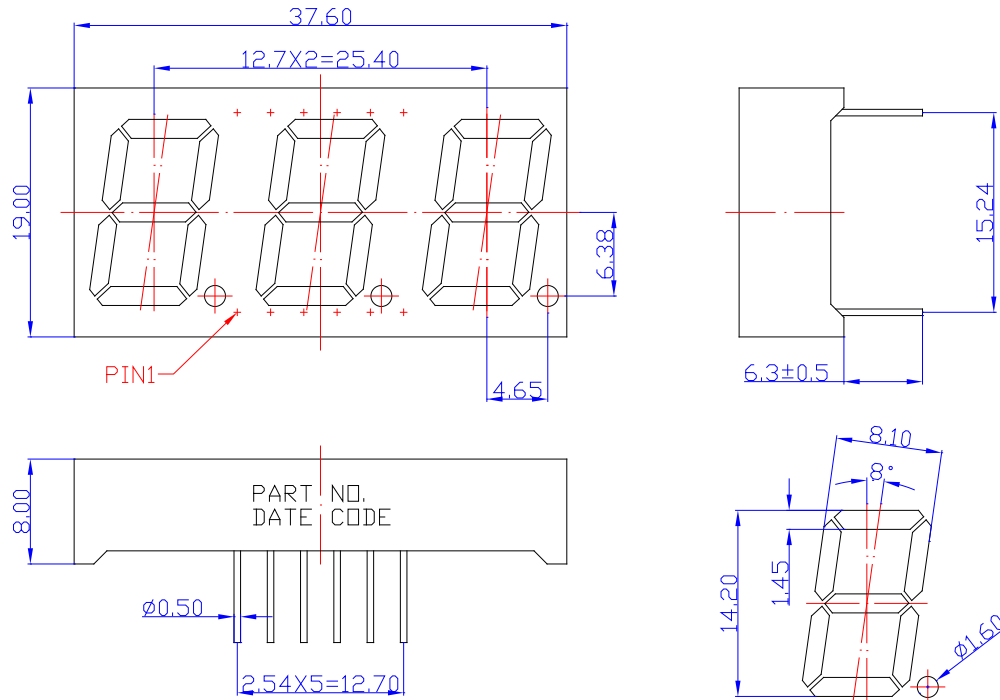
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## 0.56" Case Mold Type LED Display

### OPD-T5620LB-BW

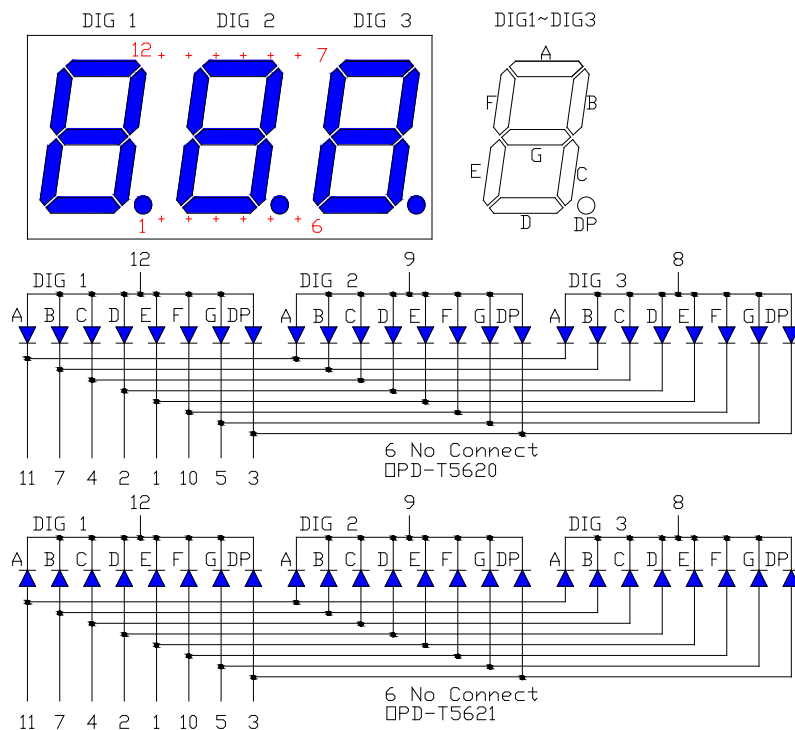
### OPD-T5621LB-BW

## MECHANICAL DIMENSIONS



NOTES: All dimensions are in millimeters. Tolerances are  $\pm 0.25$  mm unless otherwise noted.

## TYPICAL INTERNAL EQUIVALENT CIRCUIT





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● **LB: SUPER BRIGHT BLUE (InGaN/GaN)**

ABSOLUTE MAXIMUM RATING AT Ta=25°C

| Parameter                            | Symbol           | Maximum Rating | Unit |
|--------------------------------------|------------------|----------------|------|
| Power dissipation                    | P <sub>AD</sub>  | 68             | mW   |
| Continuous forward current           | I <sub>AF</sub>  | 20             | mA   |
| Peak current (duty cycle 1/10, 1kHz) | I <sub>PF</sub>  | 60             | mA   |
| Reverse voltage                      | V <sub>R</sub>   | 5              | V    |
| Operating temperature                | T <sub>OPR</sub> | -40 to +85     | °C   |
| Storage temperature                  | T <sub>STG</sub> | -40 to +85     | °C   |

ELECTRICAL - OPTICAL CHARACTERISTICS AT Ta=25°C

| Characteristic               | Symbol         | Condition            | Min. | Type. | Max. | Unit |
|------------------------------|----------------|----------------------|------|-------|------|------|
| Forward Voltage              | V <sub>F</sub> | I <sub>F</sub> =20mA | -    | 3.0   | 3.4  | V    |
| Reverse Current              | I <sub>R</sub> | V <sub>R</sub> =5V   | -    | -     | 10   | μA   |
| Dominant Wavelength          | λ <sub>D</sub> | I <sub>F</sub> =20mA | 460  | 465   | 475  | nm   |
| Luminous Intensity           | I <sub>V</sub> | I <sub>F</sub> =20mA | -    | 60    | -    | mcd  |
| Spectral Line Half-Bandwidth | Δλ             | I <sub>F</sub> =20mA | -    | 20    | -    | nm   |

## ● LB: SUPER BRIGHT BLUE (InGaN/GaN) CURVE

Typical Electro-optical Characteristic Curves  
(25 °C Free Air Temperature Unless Otherwise Specified)

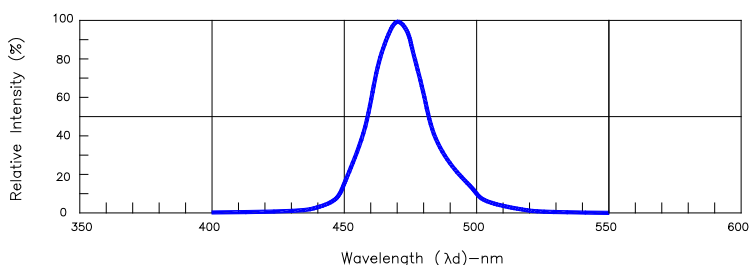


Fig.1-Relative Intensity VS. Wavelength

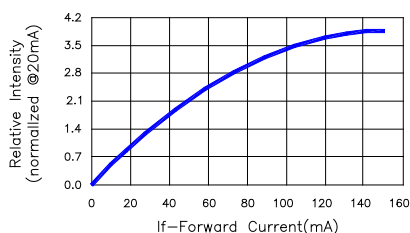


Fig.2-Relative Luminous Intensity vs. Forward Current

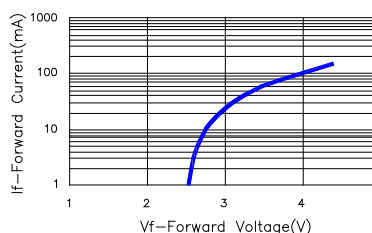


Fig.3-Forward Current vs. Forward Voltage

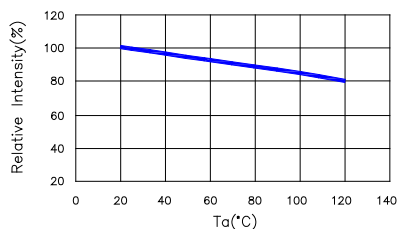


Fig.4-Relative Intensity(@20mA)VS. Ambient Temperature

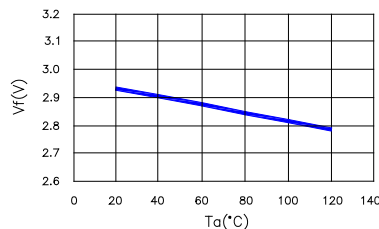


Fig.5-Forward Voltage(@20mA)VS. Ambient Temperature

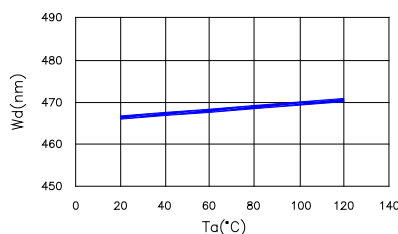


Fig.6-Dominant Wavelength(@20mA)  
VS. Ambient Temperature

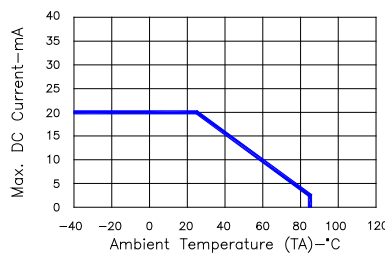
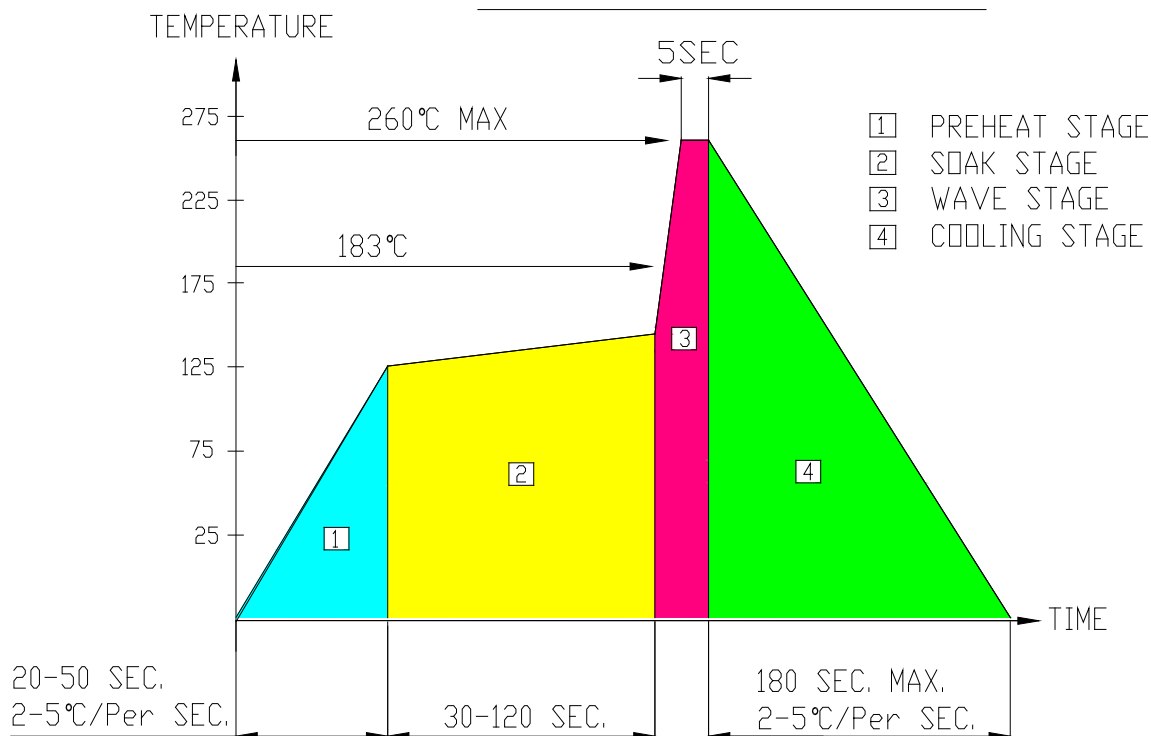


Fig.7-Max. Allowable DC Current  
VS. Ambient Temperature

## ● RECOMMEND SOLDERING PROFILE

### WAVE SOLDER PROFILE



## ● Note:

- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- Peak wave soldering temperature between 245°C ~ 225°C for 3 sec (5 sec max)
- No more than one wave soldering pass

## ● SOLDERING IRON

Basic spec is  $\leq 4$  sec when 260°C. If temperature is higher, time should be shorter (+10°C → 1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

## ● REWORK

Customer must finish rework within  $\leq 3$  sec under 350°C.  
 The head of soldering iron cannot touch copper foil.



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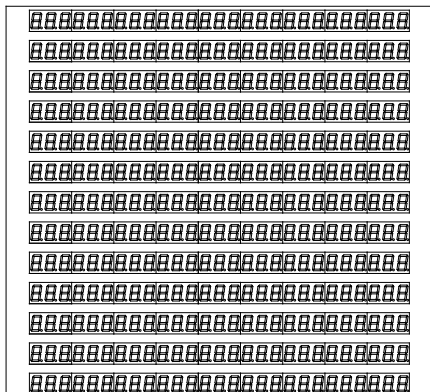
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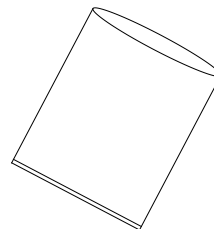
### OPD-T5621LB-BW

## ● PACKAGE DIMENSIONS

(1) 117 PCS / (9X13) Pink ESD Polyform .

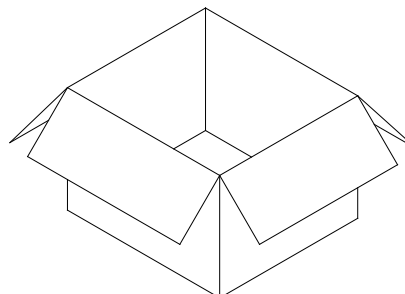


(2) 702 PCS / 6 Pink ESD Polyform / Pink 1 BAG



ESD BAG SIZE : 650 x 550 mm

(3) 1404 PCS / 2 Pink BAG / 1 OUTER CARTON



OUTER BOX SIZE : 430 x 390 x 300 mm